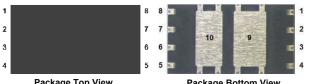
Vishay Siliconix

40 V N- and P-Channel Common Drain MOSFET Pair and 200 V N-Channel MOSFET



Package Top View **Package Bottom View**

FEATURES

- Optimized triple die package
- TrenchFET® power MOSFET
- 100 % R_q and UIS tested
- AEC-Q101 qualified
- · Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



| PRODUCT SUMMARY | | | | | | | |
|--|---------------|--------|--------|--|--|--|--|
| | N-CH 2 | P-CH 1 | N-CH 3 | | | | |
| V _{DS} (V) | 40 | -40 | 200 | | | | |
| $R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$ | 0.0092 | 0.030 | 0.060 | | | | |
| $R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$ | 0.0135 | 0.048 | - | | | | |
| I _D (A) | 30 | -30 | 20 | | | | |
| Q _g typ. (nC) | 25.5 | 30.2 | 14 | | | | |
| Configuration | N- and p-pair | | | | | | |
| Package | Triple die | | | | | | |

| Pin 1/S1 | Pin 9/D2 | Pin 10/D3 |
|------------------|------------------|------------------|
| Pin 2/G1 | Pin 3/G2 | Pin 7, 8/G3 |
| Pin 9/D1 | Pin 4/S2 | Pin 5, 6/S3 |
| P-Channel MOSFET | N-Channel MOSFET | N-Channel MOSFET |

| ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted) | | | | | | | |
|--|-------------------------|-----------------------------------|-------------|--------|--------|------|--|
| PARAMETER | | SYMBOL | N-CH 2 | P-CH 1 | N-CH 3 | UNIT | |
| Drain-source voltage | | V_{DS} | 40 | -40 | 200 | V | |
| Gate-source voltage | | V_{GS} | 20 | 20 | 20 | V | |
| Continuous drain current (T _J = 175 °C) | T _C = 25 °C | I _D | 30 | -30 | 20 | | |
| | T _C = 125 °C | | 30 | -30 | 11 | | |
| Pulsed drain current (t = 300 μs) | | I _{DM} | 120 | -120 | 60 | | |
| Overline and a state of the sta | T _C = 25 °C | I _S | 30 | -30 | 20 | A | |
| Continuous source drain current | T _C = 125 °C | | 30 | -30 | 11.4 | | |
| Single pulse avalanche current | L = 0.1 mH | I _{AS} | 26.5 | -25 | 20 | | |
| Single pulse avalanche energy | L = 0.1 MH | E _{AS} | 35 | 31 | 20 | mJ | |
| Maximum power dissipation | T _C = 25 °C | Б | 48 | 48 | 60 | W | |
| | T _C = 125 °C | P_{D} | 16 | 16 | 20 | VV | |
| Operating junction and storage temperature range | | T _J , T _{stg} | -55 to +175 | | | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|----------------------------|-------------------|--------|--------|--------|------|
| PARAMETER | SYMBOL | N-CH 2 | P-CH 1 | N-CH 3 | UNIT |
| Junction-to-case (drain) | R _{thJC} | 2.6 | 2.6 | 2.4 | °C/W |

Notes

- a. Package limited, T_C = 25 °C
- b. Surface mounted on 1" x 1" FR4 board
- d. See solder profile (www.vishay.com/doc?73257). The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components



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| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
|--|---------------------|---|--------|------|------------|--------|------|
| Static | | | | | | L | |
| | | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | N-Ch 2 | 40 | _ | - | |
| Drain-source breakdown voltage | V_{DS} | $V_{GS} = 0 \text{ V, } I_D = -250 \mu\text{A}$ | P-Ch 1 | -40 | - | - | |
| C | | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | N-Ch 3 | 200 | _ | - | |
| | | $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$ | N-Ch 2 | 1.5 | 2.0 | 2.5 | V |
| Gate-source threshold voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$ | P-Ch 1 | 1.5 | 2.0 | 2.5 | |
| | GO(iii) | $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$ | N-Ch 3 | 2.5 | 3.0 | 3.5 | |
| | | 100 100, 10 = 11 F | N-Ch 2 | - | - | ± 100 | |
| Gate-source leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | P-Ch 1 | _ | _ | ± 100 | nA |
| and a contact realising a | -000 | 100 11, 100 1 11 | N-Ch 3 | - | - | ± 100 | |
| | | V _{DS} = 40 V, V _{GS} = 0 V | N-Ch 2 | - | - | 1 | |
| | | V _{DS} = -40 V, V _{GS} = 0 V | P-Ch 1 | _ | _ | -1 | |
| | | $V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}$ | N-Ch 3 | _ | _ | 1 | |
| Zero gate voltage drain current | I _{DSS} | $V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$ | N-Ch 2 | _ | _ | 50 | mA |
| | | $V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$ | P-Ch 1 | _ | _ | -50 | |
| | | $V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$ | N-Ch 3 | - | | 50 | |
| | | $V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}, V_{J} = 120 \text{ C}$ $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ | N-Ch 2 | 25 | _ | - | |
| On-state drain current a | l=c x | $V_{DS} \le 5 \text{ V}, V_{GS} = 10 \text{ V}$ $V_{DS} \le 5 \text{ V}, V_{GS} = -10 \text{ V}$ | P-Ch 1 | -25 | _ | - | Α |
| On-state drain current | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ | N-Ch 3 | 20 | _ | _ | ^ |
| | | $V_{DS} \ge 3 \text{ V}, V_{GS} = 10 \text{ V}$ $V_{GS} = 10 \text{ V}, I_D = 9.8 \text{ A}$ | N-Ch 2 | - | 0.0077 | 0.0092 | |
| Daire and the maid and a | | | P-Ch 1 | - | 0.0077 | 0.0092 | |
| | В | $V_{GS} = -10 \text{ V}, I_D = -6 \text{ A}$ | _ | - | | | 0 |
| Drain-source on-state resistance ^a | R _{DS(on)} | $V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$ | N-Ch 3 | | 0.0500 | 0.0600 | Ω |
| | | $V_{GS} = 4.5 \text{ V}, I_D = 8.9 \text{ A}$ | N-Ch 2 | - | 0.0940 | 0.0135 | |
| | | $V_{GS} = 4.5 \text{ V}, I_{D} = -4.7 \text{ A}$ | P-Ch 1 | - | 0.0360 | 0.0480 | 0 |
| Famoured turners and outside 2 | _ | $V_{DS} = 15 \text{ V}, I_{D} = 9.8 \text{ A}$ | N-Ch 2 | - | 65 | - | |
| Forward transconductance a | 9 _{fs} | $V_{DS} = -15 \text{ V}, I_D = 6 \text{ A}$ | P-Ch 1 | - | 16 | - | S |
| Dynamic ^b | | V _{DS} = 15 V, I _D = 19 A | N-Ch 3 | - | 19 | _ | |
| Dynamic ~ | Τ | V - 20 V V - 0 V f - 1 MHz | N-Ch 2 | | 1474 | l | 1 |
| Input canacitance | | $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | P-Ch 1 | - | 1302 | - | |
| Input capacitance | C _{iss} | $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T = 1 \text{ MHz}$ $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | | - | | - | |
| | | | N-Ch 3 | - | 1450 | - | |
| Output conscitones | | $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | N-Ch 2 | - | 218 222 | - | |
| Output capacitance | C _{oss} | $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | P-Ch 1 | | 1 | | pF |
| | | $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | N-Ch 3 | - | 116 | | |
| De la constanción de | | V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHz | N-Ch 2 | - | 89 | - | |
| Reverse transfer capacitance | C _{rss} | $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | P-Ch 1 | - | 154 | - | |
| | | $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | N-Ch 3 | - | 9 | - | |
| - | | $V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$ | N-Ch 2 | - | 23 | - | |
| Total gate charge | Q_g | $V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -10 \text{ A}$ | P-Ch 1 | - | 30.2 | - | |
| | | $V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$ | N-Ch 3 | - | 14 | - | |
| | | $V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$ | N-Ch 2 | - | 4.4 | - | nC |
| Gate-source charge | Q_{gs} | $V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -10 \text{ A}$ | P-Ch 1 | - | 4.1 | - | |
| | | $V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$ | N-Ch 3 | - | 4.4 | - | |
| | | $V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$ | N-Ch 2 | - | 4.3 | | |
| Gate-drain charge | Q_{gd} | $V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -10 \text{ A}$ | P-Ch 1 | - | 7.4 | | |
| | | $V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$ | N-Ch 3 | - | 5 | - | |
| | | | N-Ch 2 | - | - | 2.1 | |
| Gate resistance | R_g | f = 1 MHz | P-Ch 1 | - | - | 9.5 | Ω |
| | | | N-Ch 3 | - | - | 2.9 | |



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| PARAMETER | SYMBOL | TEST CONDITIONS | | | TYP. | MAX. | UNIT |
|---------------------------|-----------------------|---|--------|---|-------|------|------|
| Dynamic ^b | | | | | • | | |
| | | $V_{DD} = 20 \text{ V}, \text{ R}_{L} = 2 \Omega$ $I_{D} = 10 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_{g} = 1 \Omega$ | N-Ch 2 | 1 | 8 | = | |
| Turn-on delay time | t _{d(on)} | V_{DD} = -20 V, R_L = 2 Ω I_D = -10 A, V_{GEN} = -10 V, R_g = 1 Ω | P-Ch 1 | ı | 7 | _ | |
| | | $\begin{aligned} V_{DD} &= 100 \text{ V}, R_L = 5.2 \Omega \\ I_D &= 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega \end{aligned}$ | N-Ch 3 | i | 10 | - | |
| | | $V_{DD} = 20 \text{ V}, \text{ R}_L = 2 \Omega$ $I_D = 10 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$ | N-Ch 2 | i | 12 | _ | |
| Rise time | t _r | V_{DD} = -20 V, R_L = 2 Ω I_D = -10 A, V_{GEN} = -10 V, R_g = 1 Ω | P-Ch 1 | i | 9 | - | |
| | | V_{DD} = 100 V, R_L = 5.2 Ω I_D = 10 A, V_{GEN} = 10 V, R_g = 2.5 Ω | N-Ch 3 | - | 3 | - | ,,, |
| Turn-off delay time | | $V_{DD} = 20 \text{ V}, \text{ R}_L = 2 \Omega$ $I_D = 10 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$ | N-Ch 2 | - | 22 | - | ns |
| | $t_{d(off)}$ | V_{DD} = -20 V, R_L = 2 Ω I_D = -10 A, V_{GEN} = -10 V, R_g = 1 Ω | P-Ch 1 | ı | 43 | _ | |
| | | V_{DD} = 100 V, R_L = 5.2 Ω I_D = 10 A, V_{GEN} = 10 V, R_g = 2.5 Ω | N-Ch 3 | - | 15 | - | |
| Fall time | | $V_{DD} = 20 \text{ V}, R_L = 2 \Omega$ $I_D = 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$ | N-Ch 2 | - | 10 | - | |
| | t _f | V_{DD} = -20 V, R_L = 2 Ω I_D = -10 A, V_{GEN} = -10 V, R_g = 1 Ω | P-Ch 1 | - | 19 | - | |
| | | V_{DD} = 100 V, R_L = 5.2 Ω I_D = 10 A, V_{GEN} = 10 V, R_g = 2.5 Ω | N-Ch 3 | - | 2 | - | |
| Source-Drain Diode Rating | s and Characteristics | 3 | | | | | |
| | | | N-Ch 2 | ı | - | 120 | |
| Pulsed current | I _{SM} | | P-Ch 1 | - | - | -120 | Α |
| | | | N-Ch 3 | - | - | 50 | |
| | | $I_S = 6.5 \text{ A}, V_{GS} = 0 \text{ V}$ | N-Ch 2 | - | 0.79 | - | |
| Forward voltage | V_{SD} | $I_S = -3.4 \text{ A}, V_{GS} = 0 \text{ V}$ | P-Ch 1 | - | -0.78 | - | V |
| | | $I_S = 19 \text{ A}, V_{GS} = 0 \text{ V}$ | N-Ch 3 | - | 0.9 | - | |

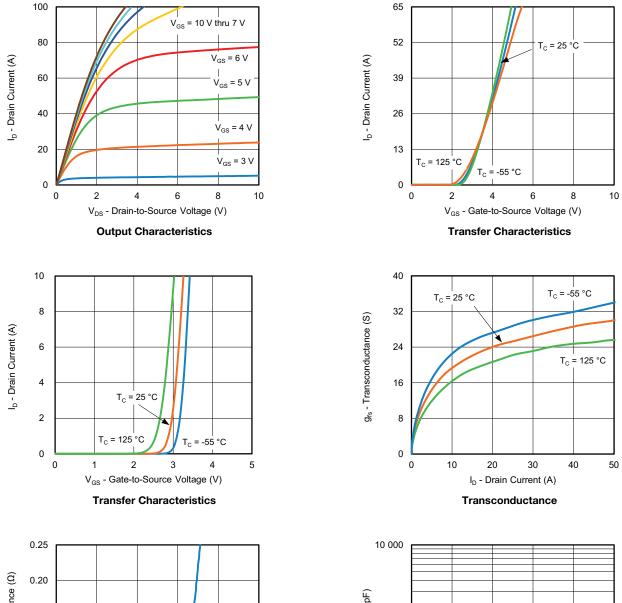
Notes

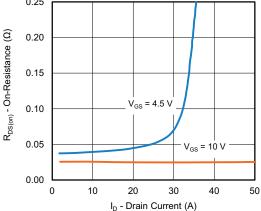
- a. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

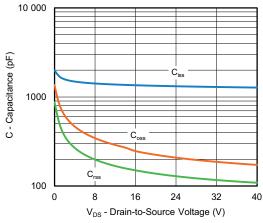


CHANNEL-1 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)





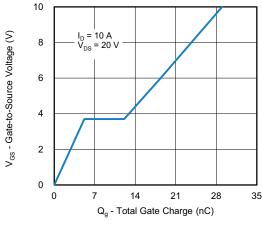




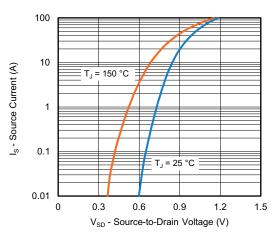
Capacitance



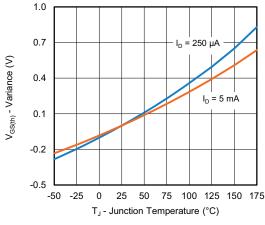
CHANNEL-1 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



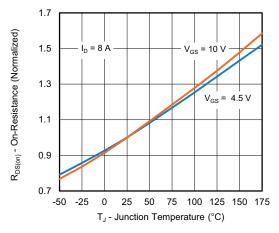
Gate Charge



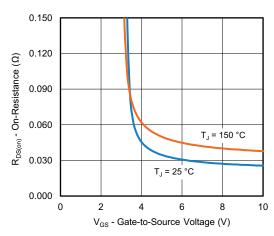
Source Drain Diode Forward Voltage



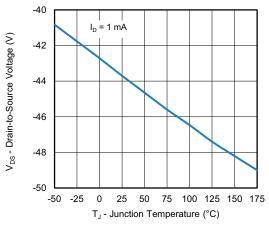
Threshold Voltage



On-Resistance vs. Junction Temperature



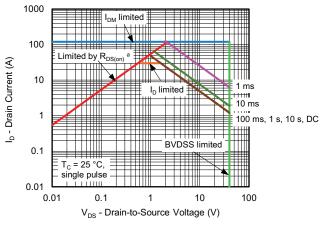
On-Resistance vs. Gate-to-Source Voltage



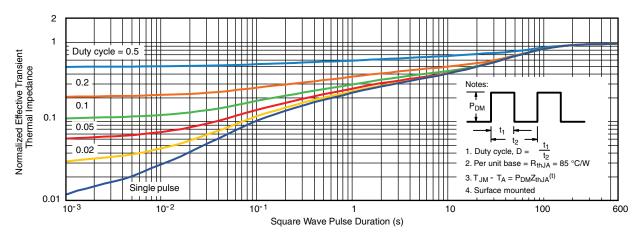
Drain Source Breakdown vs. Junction Temperature



CHANNEL-1 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Safe Operating Area



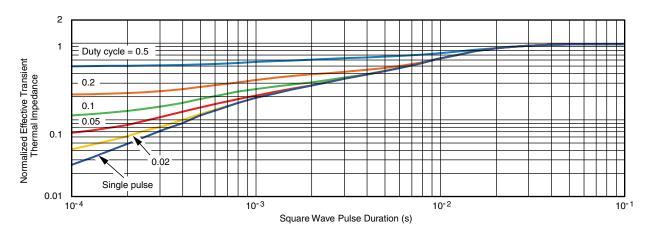
Normalized Thermal Transient Impedance, Junction-to-Ambient

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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CHANNEL-1 TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

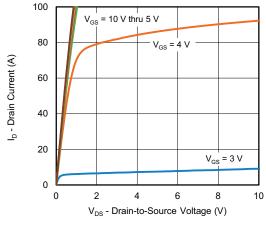
Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

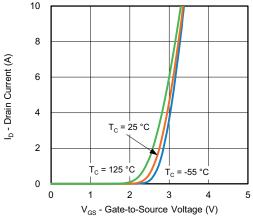
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions



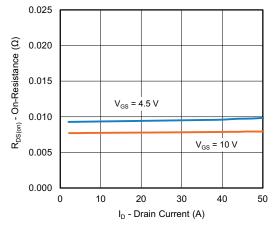
CHANNEL-2 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



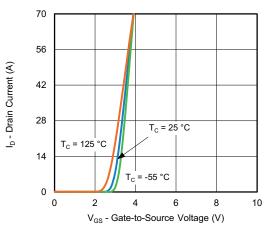
Output Characteristics



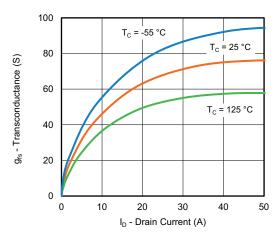
Transfer Characteristics



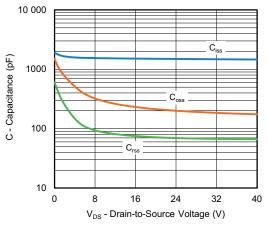
On-Resistance vs. Drain Current



Transfer Characteristics

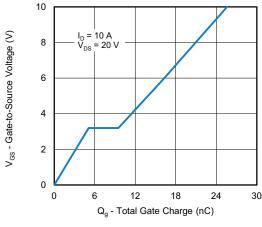


Transconductance

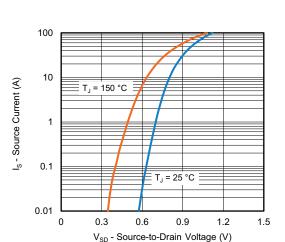




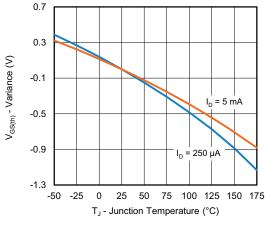
CHANNEL-2 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



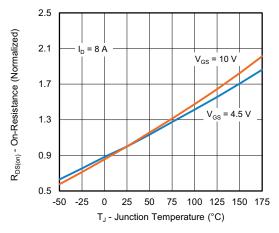
Gate Charge



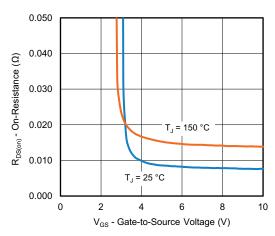
Source Drain Diode Forward Voltage



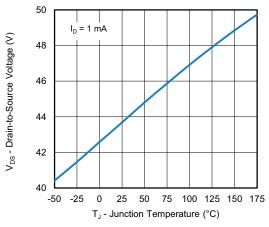
Threshold Voltage



On-Resistance vs. Junction Temperature



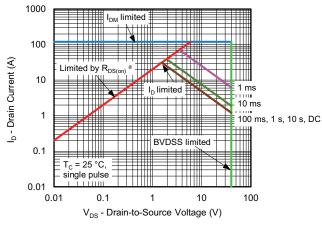
On-Resistance vs. Gate-to-Source Voltage



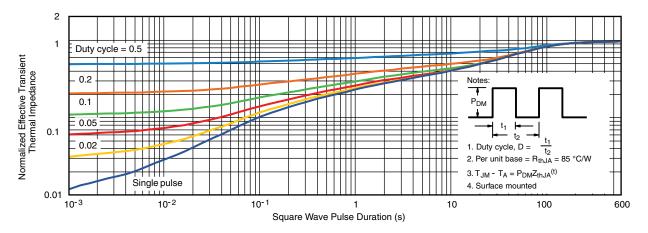
Drain Source Breakdown vs. Junction Temperature



CHANNEL-2 TYPICAL CHARACTERISTICS ($T_A = 25 \, ^{\circ}\text{C}$, unless otherwise noted)



Safe Operating Area



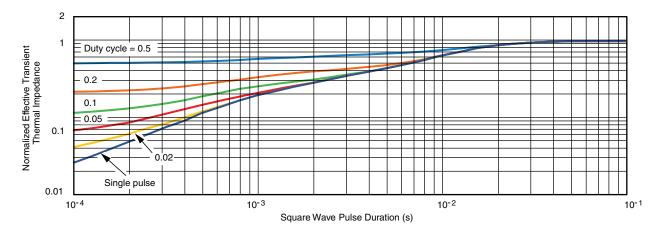
Normalized Thermal Transient Impedance, Junction-to-Ambient

Note

a. $V_{GS} > minimum \ V_{GS}$ at which $R_{DS(on)}$ is specified



CHANNEL-2 TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

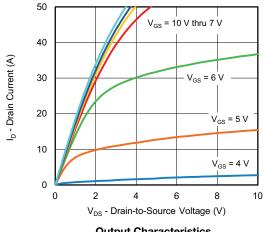
Note

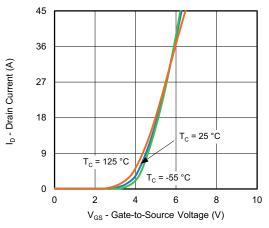
- The characteristics shown in the two graphs
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 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions



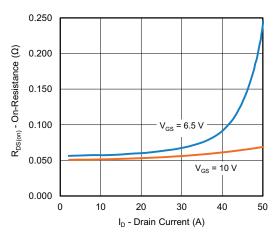
CHANNEL-3 TYPICAL CHARACTERISTICS ($T_A = 25 \, ^{\circ}\text{C}$, unless otherwise noted)

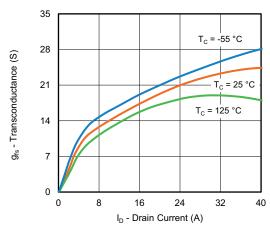




Output Characteristics

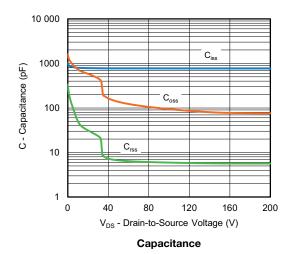
Transfer Characteristics





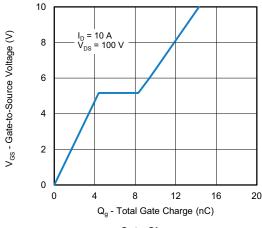
On-Resistance vs. Drain Current

Transconductance

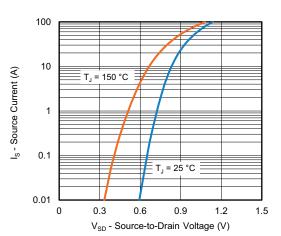




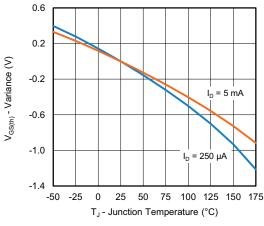
CHANNEL-3 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



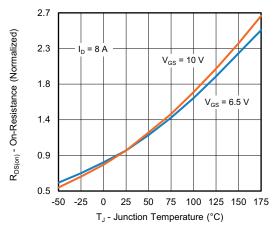




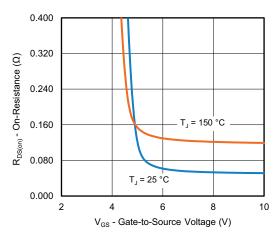
Source Drain Diode Forward Voltage



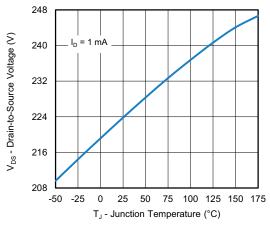
Threshold Voltage



On-Resistance vs. Junction Temperature



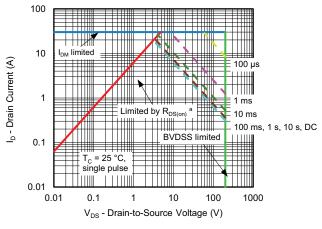
On-Resistance vs. Gate-to-Source Voltage



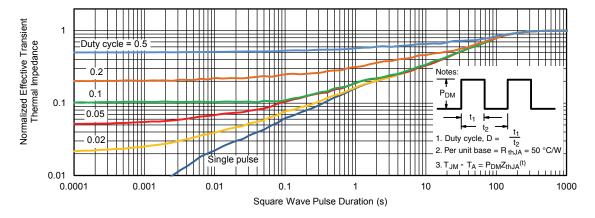
Drain Source Breakdown vs. Junction Temperature



CHANNEL-3 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

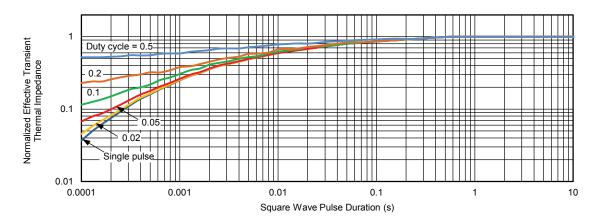
Note

a. $V_{GS} > minimum \ V_{GS}$ at which $R_{DS(on)}$ is specified

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CHANNEL-3 TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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